2SB861

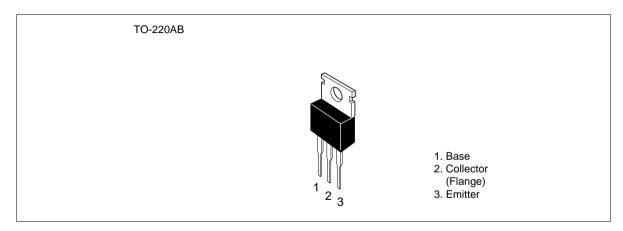
Silicon PNP Triple Diffused

HITACHI

Application

Low frequency power amplifier color TV vertical deflection output complementary pair with 2SD1138

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	-200	V
Collector to emitter voltage	V _{CEO}	-150	V
Emitter to base voltage	V_{EBO}	-6	V
Collector current	I _c	-2	A
Collector peak current	I _{C(peak)}	- 5	A
Collector power dissipation	P _c	1.8	W
	P _c *1	30	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-45 to +150	°C

Note: 1. Value at $T_c = 25^{\circ}C$



2SB861

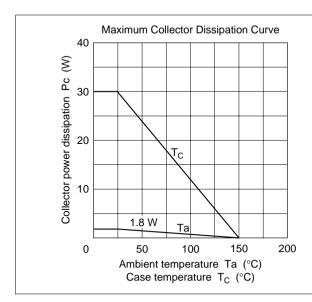
Electrical Characteristics ($Ta = 25^{\circ}C$)

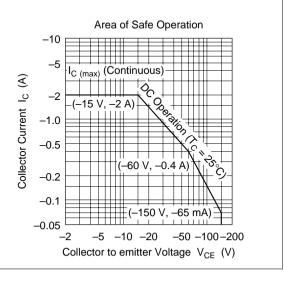
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CBO}$	-150	_	_	V	$I_{\text{C}} = -50 \text{ mA}, R_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-6	_	_	V	$I_{E} = -5 \text{ mA}, I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	-1	μΑ	$V_{CB} = -120 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1} *1	60	_	200		$V_{CE} = -4 \text{ V}, I_{C} = -50 \text{ mA}$
	h _{FE2}	60	_	_		$V_{CE} = -10 \text{ V}, I_{C} = -500 \text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-3	V	$I_{\rm C} = -500 \text{ mA}, I_{\rm B} = -50 \text{ mA}$
Base to emitter voltage	V_{BE}	_	_	-1	V	$V_{CE} = -4 \text{ V}, I_{C} = -50 \text{ mA}$
Collector output capacitance	Cob	_	30	_	pF	$V_{CB} = -100 \text{ V}, I_{E} = 0,$ f = 1 MHz

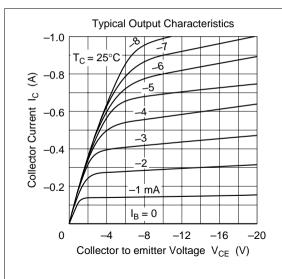
Notes: 1. The 2SB861 is grouped by h_{FE1} as follows.

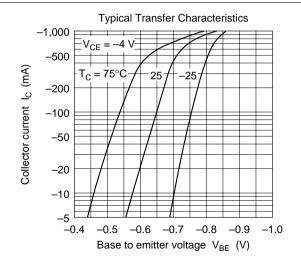
2. Pulse test

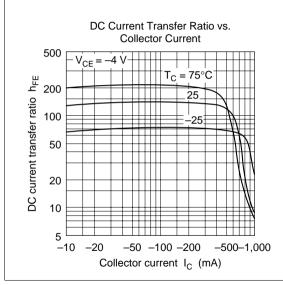
В	С
60 to 120	100 to 200

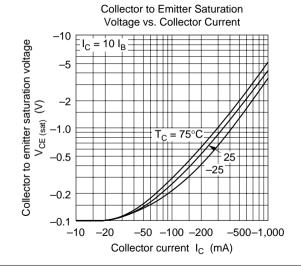




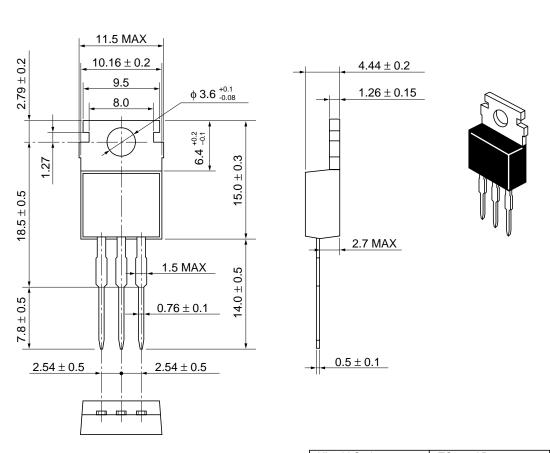








Unit: mm



Hitachi Code	TO-220AB
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.8 g

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